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Advances in Scalable Computing Services

Guest Editor:

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Deadline for manuscript submissions:

closed (20 July 2022)

Message from the Guest Editor

Dear Colleagues,

This Special Issue intends to gather the latest research and development results on the Dew Computing paradigm. It seeks original contributions, which demonstrate the theoretical and practical progress of Dew Computing, as well as implementation experiences from researchers in the area of Dew Computing, including but not limited to the following topics:

- Low-end distributed systems;
- Dew computing theory and vision;
- Dew computing structure and architecture;
- Dew, Cloudn and Fog computing integration and/or interrelation:
- Dew computing and IoT, ubiquitous computing;
- Dew computing and databases;
- Dew computing and blockchain;
- Dew computing and networks;
- Dew computing protocols and security;
- Dew computing applications.











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Editor-in-Chief

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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